

Ultra High Precision Bulk Metal[®] Foil Technology 4 Resistor Surface Mount <u>Hermetic Network</u> with 0.5 ppm/°C TCR Tracking and 0.005 % Tolerance Match





INTRODUCTION

Vishay model SMNH networks incorporate all the performance features of Vishay Bulk Metal[®] Foil technology in a product ready for surface mounting. The 8 pin gull wing side brazed DIP is the smallest ceramic package. Ceramic has the advantage of electrical isolation on the underside and high heat dissipation capability.

Resistors in network form, around the operational amplifier for example, are called upon to track at changing ambient temperature, to hold ratio under power and to force the ratio changes over a period of time to be very low.

The hermeticity, the location of the chips within the package and the "heat-sink effect" of the ceramic package itself help preserve uniform conditions inside it. The Bulk Metal Foil Vishay technology advantage in such a construction assures remarkable performance due to the following factors:

- fundamentally low TCR
- very small drift with load over time
- common behavior: all drifts move in the same direction with temperature, load and time
- TCR and tolerance match
- excellent tracking

The major highlights are emphasized by an excellent load life and shelf life ratio stability.

Vishay hermetic resistor networks are based on fabrication from a standing inventory of packages and resistor chips. This permits quick delivery of prototypes since there are no masks to design or trial processings to be made. Further, it allows any combination of values, tolerances and circuits. There are normally no engineering or setup charges, and no minimum quantities are required. Delivery can be in two weeks. (See network express prototype service.)

The sequence of fabrication includes selection of chips, die attachment, wirebonding, value trimming, and hermetic sealing. The finished product provides the stability associated with Foil resistors in a hermetically sealed package.

Hermetic sealing of Vishay's networks enhances their already inherently stable environmental performance. The result is improved load life stability and better performance during high temperature and moisture exposure.

FEATURES

 Temperature coefficient of resistance (TCR): absolute: ± 2 ppm/°C typical (- 55 °C to + 125 °C, + 25 °C ref.) tracking: ± 0.5 ppm/°C typical



RoHS³

- Resistance range: 5 Ω to 33 k Ω
- Vishay Foil resistors are not restricted to standard values; specific "as required" values can be supplied at no extra cost or delivery (e.g. 1K2345 vs. 1K)
- Power rating: at 70 °C Entire package: 0.4 W Each resistor: 0.1 W
- Resistance tolerance match: ± 0.005 %
- Load life stability per resistor: 0.005 % (0.1 W at 70 °C, 1000 h)
- Load life stability ratio: 0.005 % (0.1 W at 70 °C)
- Shelf life stability per resistor: 0.0002 % (2 ppm)
- Shelf life stability ratio: 0.0001 % (1 ppm)
- Electrostatic discharge (ESD) up to 25 000 V
- Short time overload ≤ 0.002 % (20 ppm)
- Non-inductive, non-capacitive design
- Rise time: 1 ns effectively no ringing
- Thermal stabilization time < 1 s (nominal value achieved within 10 ppm of steady state value)
- Current noise: 0.010 μV_{RMS}/V of applied voltage (< 40 dB)
- Voltage coefficient: < 0.1 ppm/V
- Non inductive: < 0.08 μH
- · Non hot spot design
- Terminal finish: gold plated (lead (Pb)-free)
- For better performances please contact us
- Available with Z-Foil technology for improved TCR to 0.2 ppm/°C
- Compliant to RoHS directive 2002/95/EC

FIGURE 1 - SCHEMATICS SMNH1 8 7 6 5 8 7 6 5 R₁ > R₂ > R₂ > R₁ > R₁ > R₂ > R₂ > R₁ > R₁ > R₂ > R₂ > R₂ > R₁ > R₂ > R₂ > R₂ > R₂ > R₁ > R₂ > R

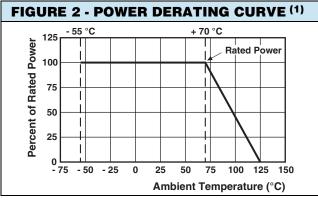
Document Number: 63092 Revision: 25-Mar-10

^{*} Pb containing terminations are not RoHS compliant, exemptions may apply

Vishay Foil Resistors

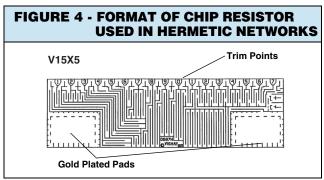


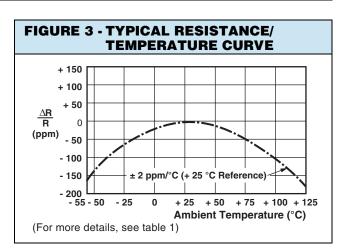
| TABLE 1 - MODEL SMNH SPECIFICATIONS | | | | | | | | |
|-------------------------------------|-------------------------------|-----------------------|-----------|---------------------|-------------|------------------|--|--|
| MODEL | ABSOI (- 55 °C to + 12 | TOLERANCE | | TCR TRACKING (max.) | | | | |
| | RESISTANCE VALUES | TYPICAL + MAX. SPREAD | ABSOLUTE | MATCH | SAME VALUES | DIFFERENT VALUES | | |
| SMNH | 500 Ω to 33 k Ω | ± 2 ± 2.5 ppm/°C | ± 0.005 % | 0.005 % | 0.5 ppm/°C | 1 ppm/°C | | |
| | 100 Ω to 500 Ω | ± 2 ± 2.5 ppin/ C | ± 0.01 % | 0.005 % | 2 ppm/°C | 3 ppm/°C | | |
| | 10 Ω to 100 Ω | ± 2 ± 3.5 ppm/°C | ± 0.02 % | 0.01 % | 4 ppm/°C | 5 ppm/°C | | |
| | 5 Ω to 10 Ω | ± 2 ± 3.3 ppm/ C | ± 0.05 % | 0.02 % | 4 ррш/ С | | | |

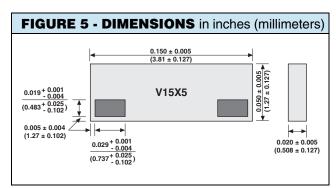


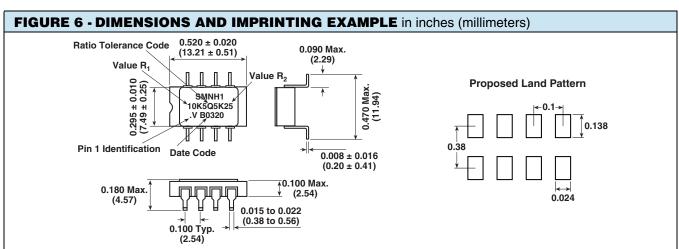
Note

 $^{(1)}$ Each resistor element 0.1 W at + 70 °C (0.4 W per package)

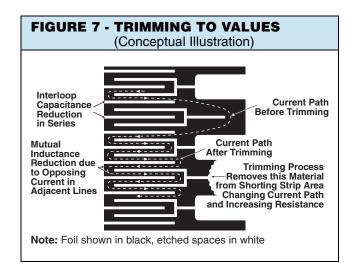












| TABLE 2 - MECI | HANICAL SPECIFICATIONS | | |
|--------------------------------|---|--|--|
| Resistive Element | High precision Bulk Metal Foil chips | | |
| Body | Ceramic package: 94 % alumina (Al ₂ O ₃) | | |
| Lid | Gold plated kovar | | |
| Terminals | Alloy 42 (iron nickel) with 100 μ" gold plating (MIL-STD-1276, type G-21-A) | | |
| Internal Connections | Gold wire bonding | | |
| Solderability | Per MIL-PRF-83401 | | |
| Marking Resistance to Solvents | Permanency testing per MIL-PRF-83401 | | |

| TABLE 3 - PERFORMANCE SPECIFICAT | TABLE 3 - PERFORMANCE SPECIFICATIONS (PER MIL-PRF 83401 TEST METHODS) | | | | | |
|--|--|--|--|--|--|--|
| SPECIFICATIONS | TYPICAL LIMITS | MAXIMUM LIMITS | | | | |
| Thermal Shock 5 x (- 65 °C to + 125 °C) and Power Conditioning 1.5 rated power at 25 °C, 100 h | $\Delta R = 0.003 \% (30 \text{ ppm})$ $\Delta Ratio = 0.001 \% (10 \text{ ppm})$ | 0.015 % (150 ppm) 0.015 % (150 ppm) | | | | |
| Low Temperature Operation | $\Delta R = 0.005 \% (50 \text{ ppm})$ $\Delta Ratio = 0.005 \% (50 \text{ ppm})$ | 0.01 % (100 ppm) 0.01 % (100 ppm) | | | | |
| Short Time Overload 6.25 rated power; 5 s | $\Delta R = 0.002 \% (20 \text{ ppm})$ $\Delta Ratio = 0.002 \% (20 \text{ ppm})$ | 0.01 % (100 ppm) 0.01 % (100 ppm) | | | | |
| Terminal Strength | $\Delta R = 0.001 \% (10 \text{ ppm})$ $\Delta Ratio = 0.001 \% (10 \text{ ppm})$ | 0.01 % (100 ppm) 0.01 % (100 ppm) | | | | |
| Resistance to Soldering Heat 260 °C, 10 s | $\Delta R = 0.002 \% (20 \text{ ppm})$ $\Delta Ratio = 0.001 \% (10 \text{ ppm})$ | 0.01 % (100 ppm) 0.01 % (100 ppm) | | | | |
| Moisture Resistance | $\Delta R = 0.003 \% (30 \text{ ppm})$ $\Delta Ratio = 0.003 \% (30 \text{ ppm})$ | 0.01 % (100 ppm) 0.01 % (100 ppm) | | | | |
| Shock 100 G, sawtooth | $\Delta R = 0.001 \% (10 \text{ ppm})$ $\Delta Ratio = 0.001 \% (10 \text{ ppm})$ | 0.01 % (100 ppm) 0.01 % (100 ppm) | | | | |
| Vibration, High Frequency | $\Delta R = 0.001 \% (10 \text{ ppm})$ $\Delta Ratio = 0.001 \% (10 \text{ ppm})$ | 0.01 % (100 ppm) 0.01 % (100 ppm) | | | | |
| Load Life 1000 h at + 70 °C; 0.1 W per resistor | $\Delta R = 0.005 \% (50 \text{ ppm})$ $\Delta Ratio = 0.005 \% (50 \text{ ppm})$ | 0.025 % (250 ppm) 0.01 % (100 ppm) | | | | |
| Load Life 1000 h at + 25 °C; 0.1 W per resistor | $\Delta R = 0.002 \% (20 \text{ ppm})$ $\Delta Ratio = 0.001 \% (10 \text{ ppm})$ | 0.01 % (100 ppm) 0.01 % (100 ppm) | | | | |
| High Temperature Exposure 100 h at + 125 °C | $\Delta R = 0.005 \% (50 \text{ ppm})$ $\Delta Ratio = 0.005 \% (50 \text{ ppm})$ | 0.01 % (100 ppm) 0.01 % (100 ppm) | | | | |
| Low Temperature Storage 24 h at - 65 °C | $\Delta R = 0.002 \% (20 \text{ ppm})$ $\Delta Ratio = 0.002 \% (20 \text{ ppm})$ | 0.01 % (100 ppm) 0.01 % (100 ppm) | | | | |
| Shelf Life Stability (6 years) | $\Delta R = 0.0002 \% (2 ppm)$ $\Delta Ratio = 0.0001 \% (1 ppm)$ | | | | | |
| Insulation Resistance 100 V (DC) | > 10 ⁴ MΩ | | | | | |
| DWV Atm. Pressure | 200 V | | | | | |
| Weight | 0.95 g | | | | | |

Notes

- ΔR's are not cumulative. For purposes of determining reliability calculations, consider the characteristics shown as figures of merit and allow no more than ± 0.05 ΔR lifetime. Allow proportionately less if the severity of anticipated environmental stresses are small compared to the tests as defined in MIL-PRF-83401.
- Post manufacturing operation (PMO) has the effect of minimizing ΔR's. Consult Vishay applications engineering for details.
- ARatio refers to the change in ratio between resistors within the network package from before, to after, the specified test.

SMNH

Vishay Foil Resistors



QUALITY INSPECTION AND TESTING

Network performance is established during the engineering design phase and is dependent on the materials of construction. Most characteristics are inherent in the Bulk Metal Foil technology and provide the high order of performance displayed throughout this catalog. Stability and drift levels can be improved beyond those shown in the catalog. Applications engineering is available to recommend screen testing beyond the standard outgoing inspection when catalog limits are insufficient. The chart below shows the standard outgoing testing and the additional user specified screen tests that may be appropriate for a particular application.

TESTING OF COMMERCIAL PRODUCT - VISHAY NETWORKS

Our standard outgoing testing consists of:

- 1. DC resistance test 100 %
 - 1. 1 Conformity to value
 - 1. 2 Conformity to tolerance
- 2. Visual and Mechanical 100 %
 - 2. 1 Conformity to physical size
 - 2. 2 Cleanliness of leads
 - 2. 3 Conformity of printing
- 3. Ship check (sample plan)
 - 3. 1 Conformity of packaging
 - 3. 2 Conformity of count

ADDITIONAL TESTING TO MIL SPEC

Group A testing to MIL-PRF-83401 imposes the following:

1. Thermal shock 100 %

5X from - 65 °C to + 125 °C

- 2. Power conditioning 100 %
 - 2. 1 100 h at 25 °C, 1.5 x rated power
 - 2. 2 ΔR and ΔR atio calculation
- 3. Visual and mechanical after the above tests (sample plan)
 - 3. 1 Conformity to physical size
 - 3. 2 Workmanship
 - 3. 3 Damage due to the above tests
- 4. 10 % PDA or one piece whichever is greater
- 5. Solderability (sample plan)

Group B sample testing to MIL-PRF-83401 imposes the following:

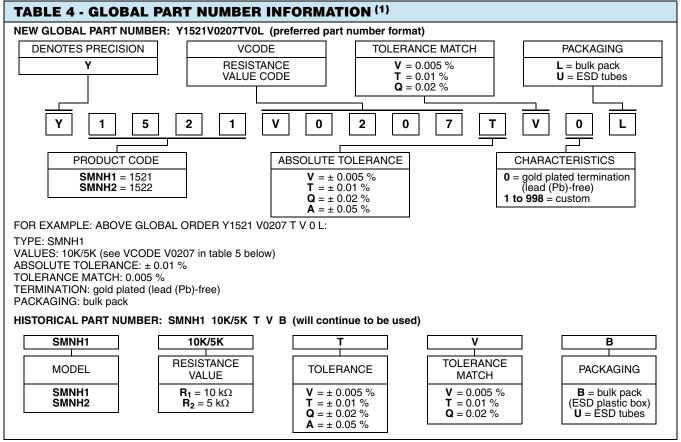
- 1. Temperature coefficient of resistance (sample plan)
- 2. Resistance to solvents (sample plan)

For any questions, contact: <u>foil@vishaypg.com</u>

Document Number: 63092

Revision: 25-Mar-10





Note

⁽¹⁾ Application engineering release: for non-standard requests, please contact application engineering

| TABLE 5 - RESISTANCE VALUE CODE LIST FOR POPULAR RATIOS | | | | | | | |
|---|---|----------------|----------------|--------|---|----------------|----------------|
| VCODES | R ₁ /R ₂ RATIO | R ₁ | R ₂ | VCODES | R ₁ /R ₂ RATIO | R ₁ | R ₂ |
| V0201 | 100 | 10K | 100R | V0189 | 2.5 | 1K | 400R |
| V0202 | 50 | 10K | 200R | V0185 | 2.5 | 500R | 200R |
| V0197 | | 5K | 100R | V0207 | | 10K | 5K |
| V0203 | 25 | 10K | 400R | V0175 | | 2K | 1K |
| V0198 | | 5K | 200R | V0190 | 2 | 1K | 500R |
| V0204 | 20 | 10K | 500R | V0182 | | 400R | 200R |
| V0193 | | 2K | 100R | V0179 | | 200R | 100R |
| V0205 | 10 | 10K | 1K | V0186 | 1.25 | 500R | 400R |
| V0194 | | 2K | 200R | V0178 | | 100R | 100R |
| V0187 | | 1K | 100R | V0180 | | 200R | 200R |
| V0200 | 5 | 5K | 1K | V0183 | | 400R | 400R |
| V0195 | | 2K | 400R | V0023 | 1 | 500R | 500R |
| V0188 | | 1K | 200R | V0191 | | 1K | 1K |
| V0184 | | 500R | 100R | V0176 | | 2K | 2K |
| V0196 | 4 | 2K | 500R | V0019 | | 5K | 5K |
| V0181 | | 400R | 100R | V0008 | | 10K | 10K |

Note

• Other values available upon request





Vishay Precision Group

Disclaimer

ALL PRODUCTS, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE.

Vishay Precision Group, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay Precision Group"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained herein or in any other disclosure relating to any product.

The product specifications do not expand or otherwise modify Vishay Precision Group's terms and conditions of purchase, including but not limited to, the warranty expressed therein.

Vishay Precision Group makes no warranty, representation or guarantee other than as set forth in the terms and conditions of purchase. To the maximum extent permitted by applicable law, Vishay Precision Group disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Information provided in datasheets and/or specifications may vary from actual results in different applications and performance may vary over time. Statements regarding the suitability of products for certain types of applications are based on Vishay Precision Group's knowledge of typical requirements that are often placed on Vishay Precision Group products. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application.

No license, express, implied, or otherwise, to any intellectual property rights is granted by this document, or by any conduct of Vishay Precision Group.

The products shown herein are not designed for use in life-saving or life-sustaining applications unless otherwise expressly indicated. Customers using or selling Vishay Precision Group products not expressly indicated for use in such applications do so entirely at their own risk and agree to fully indemnify Vishay Precision Group for any damages arising or resulting from such use or sale. Please contact authorized Vishay Precision Group personnel to obtain written terms and conditions regarding products designed for such applications.

Product names and markings noted herein may be trademarks of their respective owners.

www.vishaypg.com Revision: 27-Apr-2011